EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

Technical Data Sheet

Reverse Package Chip LED

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow

solder process.

- Mono-color type.
- Pb-free.

Descriptions

- The 23-21 SMD LED is much smaller than lead frame type components, thus enable smaller board Jorained. Junces them ideal for Jupplications. etc. Juncations • Automotive: backlighting in dashboard and switch. • Telecommunication: indicator and backlighting in telephone and fax. • Flat backlight for LCD • Generol

Applications

- General use.

Device Selection Guide

	C		
Part No.	Material	Emitted Color	Lens Color
23-21/BHC-AN1P2/2A	InGaN	Blue	Water Clear

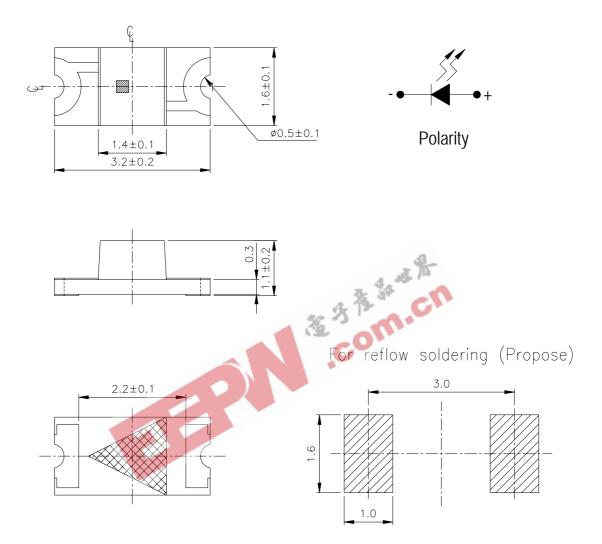


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Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

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Parameter	Symbol	Rating	Unit		
Reverse Voltage	VR	5	V		
Forward Current	IF	25	mA		
Operating Temperature	Topr	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +90	°C		
Electrostatic Discharge	ESD	150	V		
Power Dissipation	Pd	110	mW		
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	100	mA		
Soldering Temperature	Tsol	Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.			
Electro-Optical Characteristics (Ta=25°C)					

Electro-Optical Characteristics (Ta=25°(

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	28.5		72	mcd		
Peak Wavelength	λρ		468		nm		
Dominant Wavelength	λd	464.5		476.5	nm		
Spectrum Radiation Bandwidth	$ riangle \lambda$		35		nm	IF=20mA	
Viewing Angle	2 0 1/2		130		deg		
Forward Voltage	VF		3.3	3.7	V		
Reverse Current	Ir			50	μA	V _R =5V	

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

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Bin Range Of Dom. Wavelength

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Group	Bin	Min	Max	Unit	Condition
Α	A9	464.5	467.5		IF=20mA
	A10	467.5	470.5	nm	
	A11	470.5	473.5		
	A12	473.5	476.5		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition		
N1	28.5	36.0				
N2	36.0	45.0		I. 20. A		
P1	45.0	57.0	mcd	IF=20mA		
P2	57.0	72.0	ap ch			
Notes:						

Notes:

1.Tolerance of Luminous Intensity ±10%

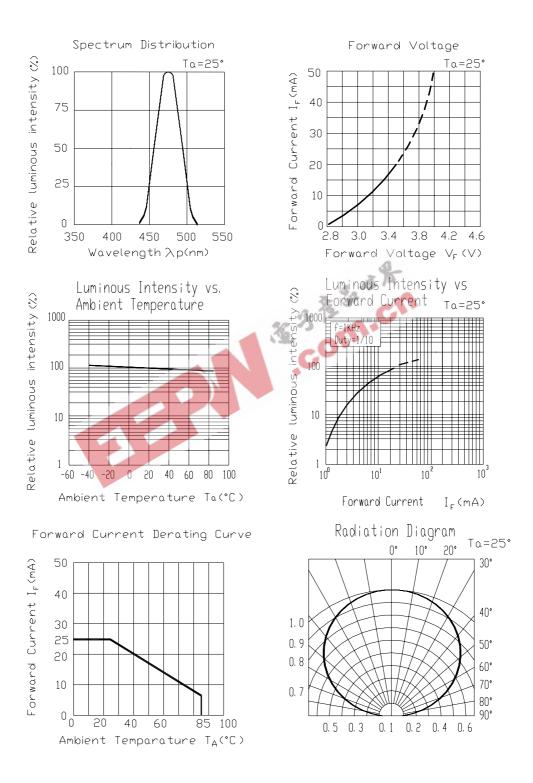
2.Tolerance of Dominant Wavelength ±1nm

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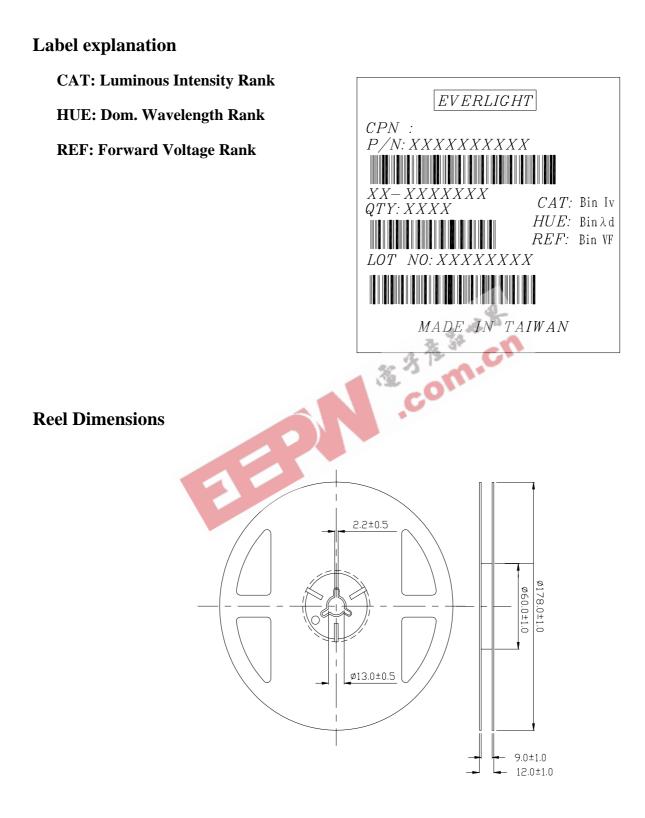
Typical Electro-Optical Characteristics Curves

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http://www.everlight.com Prepared date: 25-Mar-2005 EVERLIGHT EVERLIGHT ELECTRONICS CO., LTD.

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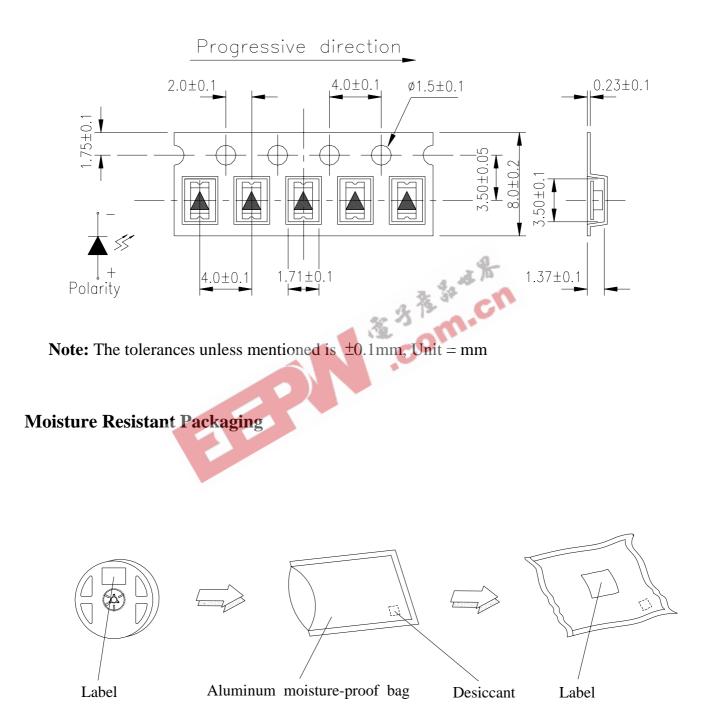
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	T emp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

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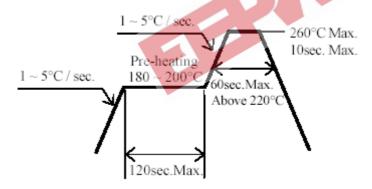
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- Do not open moisture proof bag before the products are ready to use. 2.1
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. .com.c 逐步降 Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

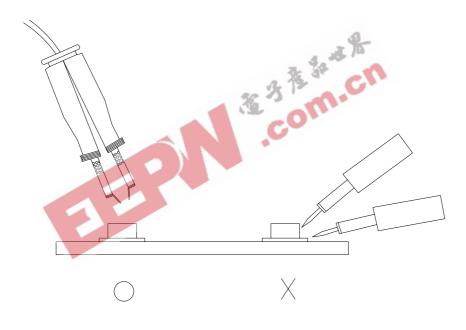
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4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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